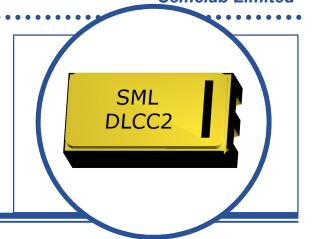


1N5806D2

Variant Options D2A to D2H

- Hermetic Ceramic Package Designed as a Drop-In Replacement for D-5A MELF Package
- Designed For High Rel Applications
- Screening Options Available



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise stated)

V _{RRM}	Maximum Reverse Repetitive Peak Voltage	150V
V_{RMS}	Maximum RMS Voltage	105V
V_{dc}	Maximum DC Blocking Voltage	150V
IO	Maximum Rectified Current $I_{O2} = T_A +55^{\circ}C^{(1)}$	1.0A
	Derate above T _A 55°C	8.33mA/°C
l _{FSM}	Non Repetitive Forward Surge Current (2)(3)	35A
Tj	Junction Temperature Range	-65 to +175°C
T _{stg}	Storage Temperature Range	-65 to +175°C

THERMAL PROPERTIES

Symbols	Parameters	Max.	Units
R ₀ JSP(IN)	Thermal Resistance, Junction To Solder Pads T _{SP} =25°C	34	°C/W
R ₀ JA(PCB)	Thermal Resistance, Junction To Ambient (3)	150	°C/W

Notes

- (1) I_{O2} is rated at 1.0A @ T_A = 55°C for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where T_J (Max) does not exceed 175°C; This equates to $R_{\theta JA(PCB)} \le 154$ °C/W.
- (2) $T_A = 25$ °C @ IO=1.0A and VRWM for ten 8.3mS surges at 1 minute intervals.
- (3) PCB = FR4, 0.0625 Inch (1.59mm) thick, single layer, 1.0-Oz Cu, Pad Size, (0.067" x 0.105")‡, (1.7mm x 2.76mm) ‡, horizontal in still air.
- ‡ Recommended solder pad layout dimensions for this device, as detailed within this datasheet for the D-5A device.



Semelab Limited reserves the right to change test conditions, parameter limits and package dimensions without notice.

Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to

SCHOTTKY RECTIFIER DIODE 1N5806D2



ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise stated)

Symbols	Parameters	Test Conditio	ns	Min	Тур	Max	Units
						0.875	
(4)	Forward Voltage	$I_{FM} = 1.0A$	T _A = 125°C			0.800	V
V _F ⁽⁴⁾			T _A = -65°C			1.075	
		I _{FM} = 2.5A	•			0.975	
IR ⁽⁴⁾	Reverse Current	V _R = 150V				1.0	1.0 175 µA
'K	Reverse Current	vK = 1204	$T_A = 125^{\circ}_{C}$			175	
V _{BR} ⁽⁴⁾	Drankdoven Valtore	Inn = 100uA		160			\/
V BR	Breakdown Voltage	I _{BR} = 100μA	T _A = -65°C	150			V

DYNAMIC CHARACTERISTICS (T_C = 25°C unless otherwise stated)

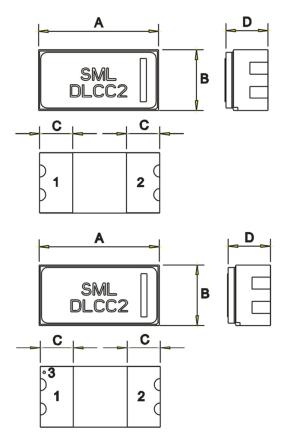
t _{rr}	Reverse Recovery Time	$I_F = I_{RM} = 0.5A$ di/dt = 65A/µs	$I_{(REC)} = 0.05A$	25	ns
CJ	Capacitance	$V_R = 10V$ f = 1.0MHz	V _{sig} = 50mV	25	рF

Notes

(4) Pulse Width \leq 380us, $\delta \leq$ 2%



MECHANICAL DATA



DLCC2 Variants A, C, D, E

Varia	int				
	D2A	Au Plated Terminals			
	D2C	Tape & Reel Option			
	D2D	Hot Solder Dipped Terminals			
	D2F	Hot Solder Dipped Terminals &			
	DZE	Tape & Reel Option			
Pin Out					
	PAD 1	ANODE			
	PAD 2	CATHODE			
	DIMENSION	mm	Inches		
	А	5.00 ±0.10	0.197 ±0.004		
	В	2.61 ±0.10	0.103 ±0.004		
	C	1.08 ±0.10	0.043 ±0.004		
	D	1.76 ±0.10	0.069 ±0.004		

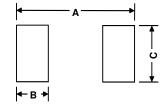
DI CC2 Variants B. F. G. H

Varia		ants b, i , C	,	
	D2B	Au Plated Terminals		
	D2F	Tape & Reel Option		
	D2G	Hot Solder Dipped Terminals		
	D2H	Hot Solder Dipped Terminals & Tape & Reel Option		
Pin O	ut			
	PAD 1	ANODE		
	PAD 2	CATHODE LID CONTACT TO CATHODE*		
	PAD 3			
	DIMENSION	mm	Inches	
	А	5.00 ±0.10	0.197 ±0.004	
	В	2.61 ±0.10	0.103 ±0.004	
	C	1.08 ±0.10	0.043 ±0.004	
	D	1.76 ±0.10	0.069 ±0.004	

^{*} The additional contact provides a connection to the lid in the application. Connecting the metal lid to a known electrical potential stops deep dielectric discharge in space applications; see the Space Weather link www.semelab.co.uk/mil/dlcc2 on the Semelab web site. The Package variant & options are to be specified when placing the order.

† The DLCC2 package design takes full advantage of the proven high reliability pedigree of the HTCC surface mount packaging technology, which is easily integrated for automated assembly. Semelab has taken the existing standards for ceramic surface mount package manufacture and added additional design features to enhance thermal performance, to present a competitive alternative for high reliability applications.

SOLDER PAD LAYOUT D-5A

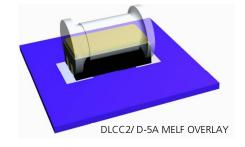


DIMENSION	mm	Inches
А	6.25	0.246
В	1.70	0.067
С	2.67	0.105

Soldering temperature should be 260°C for a maximum of 10 seconds.

PACKAGE MASS

Gold Plated Solder Pad Finish = 83mg



The physical dimensions for the DLCC2 ceramic package are designed to be different from the published dimensions for the "D-5A" and "B-MELF" outlines. The DLCC2 design fully utilises the recommended solder footprint for the "D-5A" / "B-MELF" Package, and as such presents a drop in replacement for existing board designs.

ULTRAFAST RECOVERY RECTIFIER DIODE 1N5806D2



SCREENING OPTION

Space Level (JQRS/ESA) and High Reliability options are available in accordance with the High Reliability and Screening Options Handbook available for download from the from the TT electronics Semelab web site.

ESA Quality Level Products are based on the testing procedures specified in the generic ESCC 5000 and in the corresponding part detail specifications.

Semelabs QR216 and QR217 processing specifications (JQRS), in conjunction with the companies ISO 9001:2000 approval present a viable alternative to the American MIL-PRF-19500 space level processing.

QR217 (Space Level Quality Conformance) is based on the quality conformance inspection requirements of MIL-PRF-19500 groups A (table V), B (table VIa), C (table VII) and also ESA / ESCC 5000 (chart F4) lot validation tests.

QR216 (Space Level Screening) is based on the screening requirements of MIL-PRF-19500 (table IV) and also ESA /ESCC 5000 (chart F3).

JQRS parts are processed to the device data sheet and screened to QR216 with conformance testing to Q217 groups A and B in accordance with MIL-STD-750 methods and procedures.

Additional conformance options are available, for example Pre-Cap Visual Inspection, Buy-Off Visit or Data Packs. These are chargeable and must be specified at the order stage (See Ordering Information). Minimum order quantities may apply.

Alternative or additional customer specific conformance or screening requirements would be considered. Contact Semelab sales with enquires.

MARKING DETAILS

Parts can be laser marked with approximately 7 characters on two lines and always includes cathode identification. Typical marking would include part or specification number, week of seal or serial number subject to available space and legibility.

Customer specific marking requirements can be arranged at the time of order.

Example Marking:



ORDERING INFORMATION

Part numbers are built up from Type, Package Variant, and screening level. The part numbers are extended to include the additional options as shown below.

Type – See Electrical Characteristics Table Package Variant – See Mechanical Data Screening Level – See Screening Options (ESA / JQRS)

Additional Options:

Customer Pre-Cap Visual Inspection	.CVP
Customer Buy-Off visit	.CVB
Data Pack	.DA
Solderability Samples	.SS
Scanning Electron Microscopy	.SEM
Radiography (X-ray)	.XRAY
Total Dose Radiation Test	.RAD
MIL-PRF-19500 (QR217)	
Group B charge	.GRPB
Group B destructive mechanical samples	.GBDM (12 pieces)
Group C charge	.GRPC
Group C destructive electrical samples	.GCDE (12 pieces)
Group C destructive mechanical samples	.GCDM (6 pieces)
ESA/ESCC	
Lot Validation Testing (subgroup 1) charge	.LVT1
LVT1 destructive samples (environmental)	.L1DE (15 pieces)
LVT1 destructive samples (mechanical)	.L1DM (15 pieces)
Lot Validation Testing (subgroup 2) charge	.LVT2
LVT2 endurance samples (electrical)	.L2D (15 pieces)
Lot Validation Testing (subgroup 3) charge	.LVT3
LVT3 destructive samples (mechanical)	.L3D (5 pieces)

Additional Option Notes:

- 1) All 'Additional Options' are chargeable and must be specified at order stage.
 2) When Group B,C or LVT is required, additional electrical and mechanical destructive
- 3) All destructive samples are marked the same as other production parts unless otherwise requested.

Example ordering information:

The following example is for the 1N5806 part with package variant B, JQRS screening, additional Group C conformance testing and a Data pack.

Part Numbers:

1N5806D2B-JQRS (Include quantity for flight parts) 1N5806D2B-JQRS.GRPC (chargeable conformance option) 1N5806D2B-JQRS.GCDE (charge for destructive parts) 1N5806D2B-JQRS.GCDM (charge for destructive parts) 1N5806D2B-JQRS.DA (charge for Data pack)

Customers with any specific requirements (e.g. marking or screening) may be supplied with a similar alternative part number (there is maximum 20 character limit to part numbers). Contact Semelab sales with enquiries.

Website: http://www.semelab-tt.com

High Reliability and Screening Options Handbook link: http://www.semelab.co.uk/pdf/misc/documents/hirel_and_screening_options.pdf